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Attorney Docket No. 10553R0406

In Re Application of:

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Commissioner for Patents
P.O. Box 1450
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Pursuant to 37 C.F.R. §1.97, Applicant hereby calls the Examiner's attention to documents listed on the attached form, which documents may be material to the examination of this application. Pursuant to 37 CFR §1.98(a)(2)(i) copies of cited US patent and US patent application publications are not submitted herewith. Copies of foreign patent documents and non-patent literature documents are enclosed herewith for the Examiner's consideration.

US Patent No. 6,825,488 B2
US Patent Application Publication No. US 2002/0110941 A1
US Patent Application Publication No. US 2005/0056848 A1

The family of JP 09-045927 cited herein includes:

US Patent No. 6,166,396

US Patent No. 6,495,857 B2

US Patent Application Publication No. US 2001/0001496 A1

The family of JP 10-032202 cited herein includes:

US Patent No. 5,929,527

US Patent No. 6,844,628 B2

US Patent Application Publication No. US 2002/0179973 A1

US Patent No. 6,940,094 B2

US Patent Application Publication No. US 2002/0179972 A1

US Patent No. 6,979,882 B1

US Patent Application Publication No. US 2005/0206008 A1

The family of JP 06-232129 cited herein includes:

US Patent No. 5,623,157

US Patent No. 5,804,878

US Patent No. 6,031,290

US Patent No. 6,166,414

US Patent No. 6,448,612 B1

US Patent No. 6,608,353 B2

US Patent Application Publication No. US 2002/0179969 A1

US Patent Application Publication No. US 2004/0023445 A1

US Patent Application Publication No. US 2004/0051102 A1

US Patent Application Publication No. US 2005/0145847 A1

The family of JP 08-330600 cited herein includes:

US Patent No. 5,640,067

US Patent No. 5,897,328

US Patent No. 6,853,083 B1

US Patent No. 6,992,435 B2

US Patent Application Publication No. US 2005/0146262 A1

No inference should be drawn that the attached list sets forth a comprehensive investigation of the prior art, that any or all are pertinent to the invention, or that any apparatus disclosed is equivalent to the subject invention.

The citation of the above-discussed documents is not to be construed as an assertion that more pertinent art could not

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possibly be in existence. Citation of any document herein is not to be construed as an admission that any subject matter disclosed in the document is necessarily within the inventive field of endeavor, that any disclosure is necessarily prior in time to a particular date which may be relevant to the instant patent application, and/or that any disclosure is otherwise necessarily prior art with respect to the instant invention.

Applicant also respectfully reserves the right to later set forth how the instant invention is distinguished over the disclosure of any document or other art, including the disclosure of those documents discussed herein, that may be cited by the Examiner in rejecting a claim in the instant patent application.

A first office action, notice of allowance or issue fee notification has not been received in this case, so Applicant does not believe that a fee is due. However, if any such fee is required, please charge our Deposit Account No. 50/1039.

Respectfully submitted,



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10/576177

JAP20R034767P10 19 APR 2006

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	DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE
	JP 06-202146	07/22/94	Fujitsu Ltd	X		12/28/92
	JP 06-232129	08/19/94	Semiconductor Energy Lab Co Ltd	X		01/18/93
	JP 07-312425	11/28/95	Hitachi Ltd	X		05/18/94
	JP 08-330600	12/13/96	TDK Corp	X		03/22/96
	JP 09-045927	02/14/97	Semiconductor Energy Lab Co Ltd	X		07/27/95
	JP 10-032202	02/03/98	Semiconductor Energy Lab Co Ltd	X		07/16/96
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	JP 2001- 281704	10/10/01	Semiconductor Energy Lab Co Ltd	X		01/26/01
	JP 2004- 006974	01/08/04	Semiconductor Energy Lab Co Ltd	X		08/04/03

OTHER PRIOR ART - NON-PATENT LITERATURE DOCUMENTS
(Including Author, Title, Date, Pertinent Pages)

- 1) International Search Report re application no. PCT/JP2005/017223, dated December 27, 2005.
- 2) Written Opinion re international application no. PCT/JP 2005/017223, dated December 27, 2005.

EXAMINER:

DATE CONSIDERED:

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.

1AP20 Rec'd PCTPTO 19 APR 2006

LIST OF PUBLICATIONS CITED BY APPLICANT	Atty. Docket No. 0553-0494	Serial No. Not Assigned 1576177
	Applicant Yoshinari HIGAKI et al	
	Filing Date Herewith	Group

US PATENT DOCUMENTS

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	6,853,083 B1	02/08/05	Yamauchi et al	257	763	03/11/99
	6,861,670 B1	03/01/05	Ohtani et al	257	66	03/28/00
	US 2005/ 0056848 A1	03/17/05	Yamazaki et al	257	72	10/07/04
	US 2005/ 0145847 A1	07/07/05	Miyazaki et al	257	72	12/28/04
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OTHER PRIOR ART - NON-PATENT LITERATURE DOCUMENTS
(Including Author, Title, Date, Pertinent Pages)

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LIST OF PUBLICATIONS CITED BY APPLICANT			Atty. Docket No. 0553-0494	Serial No. 10/576177 Not Assigned		
			Applicant Yoshinari HIGAKI et al			
			Filing Date Herewith	Group		
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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	5,623,157	04/22/97	Miyazaki et al	257	383	06/07/95
	5,640,067	06/17/97	Yamauchi et al	313	504	03/18/96
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